

Chip Ferrite Bead BLM03H□□□□SH1D Murata Standard Reference Specification [AEC-Q200]

1.Scope

This reference specification applies to Chip Ferrite Bead for Automotive Electronics BLM03H SH series based on AEC-Q200.

2.Part Numbering

03 (ex.) <u>BL M</u> <u>HG 601</u> (4) (2) (5)

(1)Product ID (4)Characteristics (7)Category(for Automotive Electronics)

(2)Type

(5)Typical Impedance at 100MHz (3)Dimension (L×W) (6)Performance(S:general/F:Low Rdc)

(8) Numbers of Circuit (9)Packaging (D:Taping)

3.Rating

Customer Part Number	MURATA Part Number	Impedance (Ω) (Under Standard Testing Condition)		` '	$\begin{array}{c} \text{DC Resistance} \\ (\Omega \text{ max.}) \\ (\text{refer to below} \\ \text{comment}) \\ \\ \text{Initial} \qquad \text{Values} \end{array}$	ESD Rank 2 :2kV	
		at100MHz	at1GHz		Values	After Testing	
	BLM03HG601SH1D	600±25%	1000±40%	150	1.6	1.7	
	BLM03HG102SH1D	1000±25%	1800±40%	125	2.6	2.7	2
	BLM03HG122SH1D	1200±25%	2000±40%	100	3.5	3.6	

■Operating Temperature : -55°C to +125°C ■Storage Temperature : -55°C to +125°C

Standard Testing Conditions

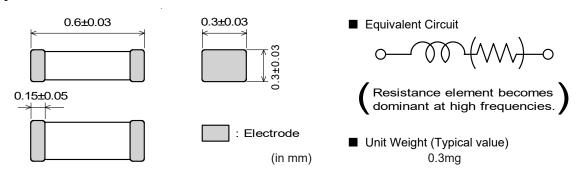
< Unless otherwise specified >

Temperature: Ordinary Temp. (15 °C to 35 °C) Humidity: Ordinary Humidity (25%(RH)) to 85%(RH)) < In case of doubt >

Temperature: 20°C±2 °C Humidity: 60%(RH) to 70%(RH)

Atmospheric pressure: 86kPa to 106kPa

4. Style and Dimensions



5.Marking

No marking.



6.Specifications

6-1. Electrical Performance

No.	Item	Specification	Test Method	
6-1-1	Impedance	Meet item 3.	Measuring Frequency : 100MHz±1MHz,1GHz±1MHz	
			Measuring Equipment : KEYSIGHT4291A or the	
			equivalent	
			Test Fixture : KEYSIGHT16192A or the equivalent	
6-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter	
			*Except resistance of the Substrate and Wire	

6-2.Mechanical Performance (based on Table 13 for FILTER EMI SUPPRESSORS/FILTERS) AEC-Q200 Rev.D issued June. 1 2010

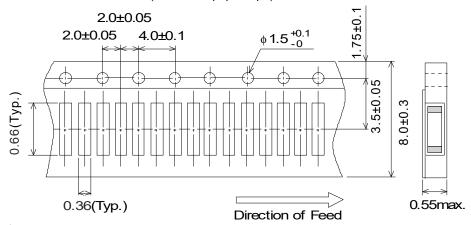
AEC-Q200 Murata Specification / Deviation No. Stress Test Method High 1000hours at 125 deg C Meet Table A after testing. Temperature Set for 24hours Table A Exposure at room temperature, Appearance No damage then measured. Impedance Change Within ±50% (at 100MHz) DC Meet item 3. Resistance Temperature Cycling 1000cycles Meet Table A after testing. -55 deg C to +125 deg C Set for 24hours at room temperature, then measured. Destructive Per FIA469 No defects No electrical tests Physical Analysis 1000hours at 85 deg C, 85%RH Biased Humidity Meet Table A after testing. Apply max rated current. Operational Life Apply 125 deg C 1000hours Meet Table A after testing. Set for 24hours at room temperature, then measured External Visual No abnormalities Visual inspection 10 Physical Dimension Meet ITEM 4 No defects (Style and Dimensions) 12 Resistance Per MIL-STD-202 Method 215 Not Applicable to Solvents 13 Mechanical Shock Per MIL-STD-202 Method 213 Meet Table B after testing. Condition F: Table B 1500g's(14.7N)/0.5ms/Half sine Appearance No damage Impedance Change Within ±30% (at 100MHz) DC Meet item 3. Resistance 14 Vibration 5g's(0.049N) for 20 minutes Meet Table B after testing. 12cycles each of 3 oritentations Test from 10-2000Hz. 15 Resistance Solder temperature Pre-heating: 150C +/-10 deg C, 60s to 90s to Soldering Heat 260C+/-5 deg C Immersion time 10s Meet Table B after testing.



AEC-Q200		EC-Q200	Manada Conseiferation / Desightion
No.	Stress	Test Method	Murata Specification / Deviation
17	ESD	Per AEC-Q200-002	Meet Table B after testing. ESD Rank: Meet Item 3. (Rating)
18	Solderability	Per J-STD-002	Method b : Not Applicable 95% of the terminations is to be soldered.
19	Electrical Characterization	Measured : Impedance	No defects
20	Flammability	Per UL-94	Not Applicable
21	Board Flex	Epoxy-PCB(1.0mm) Deflection 2mm(min) 60s minimum holding time	Meet Table B after testing.
22	Terminal Strength	Per AEC-Q200-006	Murata deviation request: 5N No defects
30	Electrical Transient Conduction	Per ISO-7637-2	Not Applicable

7. Specification of Packaging

7-1. Appearance and Dimensions (8mm-wide paper tape)



(1) Taping

Products shall be packaged in the cavity of the base tape of 8mm-wide, 2mm-pitch continuously and sealed by cover tape.

- (2) Sprocket hole: The sprocket holes are to the right as the tape is pulled toward the user.
- (3) Spliced point: The base tape and cover tape tape have no spliced point
- (4) Cavity: There shall not be burr in the cavity.
- (5) Missing components number

Missing components number within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept..

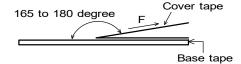
7-2. Tape Strength



Cover tape 5N min.

(2)Peeling off force of Cover tape

0.1N to 0.6N (Minimum value is typical.) *Speed of Peeling off:300mm/min



7-3. Taping Condition

(1)Standard quantity per reel

Quantity per 180mm reel	10000 pcs. / reel

Spec.No.JENF243A-9134C-01

(2)There shall be leader-tape(top tape and empty tape) and trailer- tape(empty tape) as follows.

(3)On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.

(4)Marking for reel

The following items shall be marked on a label and the label is stuck on the reel.

(Customer part number, MURATA part number, Inspection number(*1), RoHS marking(*2), Quantity, etc)

*1) « Expression of Inspection No. »

 $\frac{\square\square}{(1)}$ $\frac{OOOO}{(2)}$ $\frac{\times\times\times}{(3)}$

(1) Factory Code (2) Date

First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O,N,D

P.4/9

Third, Fourth digit: Day

(3) Serial No.

*2) « Expression of RoHS marking »

ROHS $-\frac{Y}{(1)}(\underline{\Delta})$

(1) RoHS regulation conformity parts.

(2) MURATA classification number

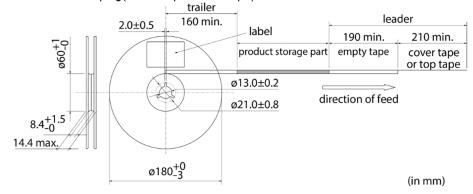
(5)Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

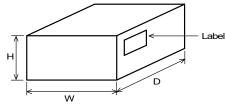
(Customer name, Purchasing order number, Customer part number, MURATA part number,

RoHS marking(*2), Quantity, etc)

(6)Dimensions of reel and taping(leader-tape, trailer-tape)



7-4. Specification of Outer Case



Outer	Case Dime (mm)	nsions	Standard Reel Quantity in Outer Case (Reel)
W	D	Н	(Reei)
186	186	93	5

* Above Outer Case size is typical. It is depend on a quantity of an order.



8. 🛕 Caution

8-1.Rating

Do not use products beyond the Operating Temperature Range and Rated Current.

8-2. Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise.

Please contact us in advance in case of applying the surge current.

8-3.Fail Safe

Be sure to provide an appropriate fail-safe function on your product to prevent from a second damage that may be caused by the abnormal function or the failure of our products.

8-4. Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

(1)Aircraft equipment (6)Disaster prevention / crime prevention equipment

(2)Aerospace equipment (7)Traffic signal equipment

(3)Undersea equipment (8)Transportation equipment (trains, ships, etc.)

(4)Power plant control equipment (9) Data-processing equipment

(5)Medical equipment (10)Applications of similar complexity and /or reliability requirements to the applications listed in the above

8-5. Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.



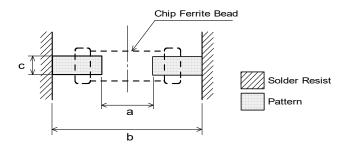
9. Notice

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

9-1.Land pattern designing

• Standard land dimensions (Reflow soldering)



а	b	С
0.25	0.80	0.30

(in mm)

9-2. Soldering Conditions

Products can be applied to reflow soldering.

(1) Flux, Solder

Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.)
	Do not use water-soluble flux.
Solder	Use Sn-3.0Ag-0.5Cu solder
	Standard thickness of solder paste : 100 μm to 150 μm

(2) Soldering conditions

• Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

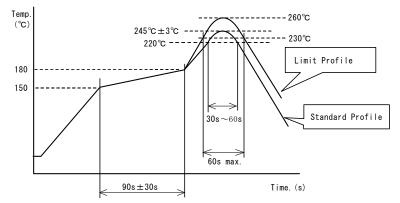
Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

Standard soldering profile and the limit soldering profile is as follows.
 The excessive limit soldering conditions may cause leaching of the electrode and / or resulting

in the deterioration of product quality.

Reference Only

(3) Soldering profile



	Standard Profile	Limit Profile
Pre-heating	150~180°C 、90s±30s	
Heating	above 220°C、30s∼60s	above 230°C、60s max.
Peak temperature	245±3°C	260°C,10s
Cycle of reflow	2 times	2 times

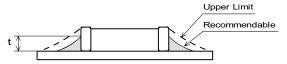
9-3. Soldering iron

- Pre-heating: 150°C, 1 min
- Soldering iron output: 80W max.
- Tip temperature: 350°C max.
- \bullet Tip diameter: ϕ 3mm max.
- Soldering time: 3(+1,-0) seconds.
- Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

9-4. Solder Volume

Solder shall be used not to be exceeded as shown below.



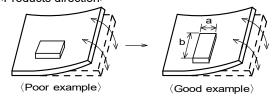
1/3T≦t≦T (T:Chip thickness)

Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

9-5. Attention regarding P.C.B. bending

The following shall be considered when designing and laying out P.C.B.'s.

(1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage. <Products direction>



Products shall be located in the sideways direction (Length:a
b) to the mechanical stress.

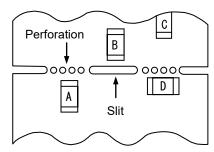


(2)Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

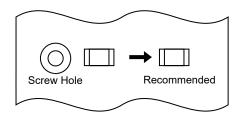
Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C



*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

(3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



9-6. Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

9-7. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl2, H2S, NH3, SO2, NO2,etc)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

9-8. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.



9-9. Cleaning

When cleaning this product, observe the following conditions.

Any cleaning may cause deterioration in the quality of the product, so please check the quality of this product before use.

- (1) The cleaning temperature shall be 60°C max. If isopropyl alcohol (IPA) is used, the cleaning temperature shall be 40°C max.
- (2) When ultrasonic cleaning is used, under some cleaning conditions, the substrate could resonate and the substrate vibrations could result in chip cracks, solder breakage, and other problems. Be sure to always perform a test cleaning beforehand using an actual cleaning device, and then check the quality of the products.
- (3) Cleaner

Alcohol-based cleaner: IPA

Aqueous agent: PINE ALPHA ST-100S

(4) There shall be no residual flux or residual cleaner.

When using aqueous agent, rinse the product with deionized water adequately and completely dry it so that no cleaner is left.

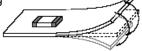
* For other cleaning, please consult our technical department.

9-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.





Twisting



9-11. Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

• Products should be stored in the warehouse on the following conditions.

Temperature: -10°C to 40°C

Humidity : 15% to 85% relative humidity No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Avoid storing the product by itself bare (i.e.exposed directly to air).

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

10. 🛆 Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2)You are requested not to use our product deviating from the reference specifications.
- (3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

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